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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	33MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/p80c32ubaa-512

80C51 8-bit microcontroller family

128/256 byte RAM ROMless low voltage (2.7V–5.5V), low power, high speed (33 MHz)

80C31/80C32

DESCRIPTION

The Philips 80C31/32 is a high-performance static 80C51 design fabricated with Philips high-density CMOS technology with operation from 2.7 V to 5.5 V.

The 80C31/32 ROMless devices contain a 128×8 RAM/ 256×8 RAM, 32 I/O lines, three 16-bit counter/timers, a six-source, four-priority level nested interrupt structure, a serial I/O port for either multi-processor communications, I/O expansion or full duplex UART, and on-chip oscillator and clock circuits.

In addition, the device is a low power static design which offers a wide range of operating frequencies down to zero. Two software selectable modes of power reduction—idle mode and power-down mode are available. The idle mode freezes the CPU while allowing the RAM, timers, serial port, and interrupt system to continue functioning. The power-down mode saves the RAM contents but freezes the oscillator, causing all other chip functions to be inoperative. Since the design is static, the clock can be stopped without loss of user data and then the execution resumed from the point the clock was stopped.

SELECTION TABLE

For applications requiring more ROM and RAM, see the 8XC54/58 and 8XC51RA+/RB+/RC+/80C51RA+ data sheet.

ROM/EPROM Memory Size (X by 8)	RAM Size (X by 8)	Programmable Timer Counter (PCA)	Hardware Watch Dog Timer
80C31/8XC51			
0K/4K	128	No	No
80C32/8XC52/54/58			
0K/8K/16K/32K	256	No	No
80C51RA+/8XC51RA+/RB+/RC+			
0K/8K/16K/32K	512	Yes	Yes
8XC51RD+			
64K	1024	Yes	Yes

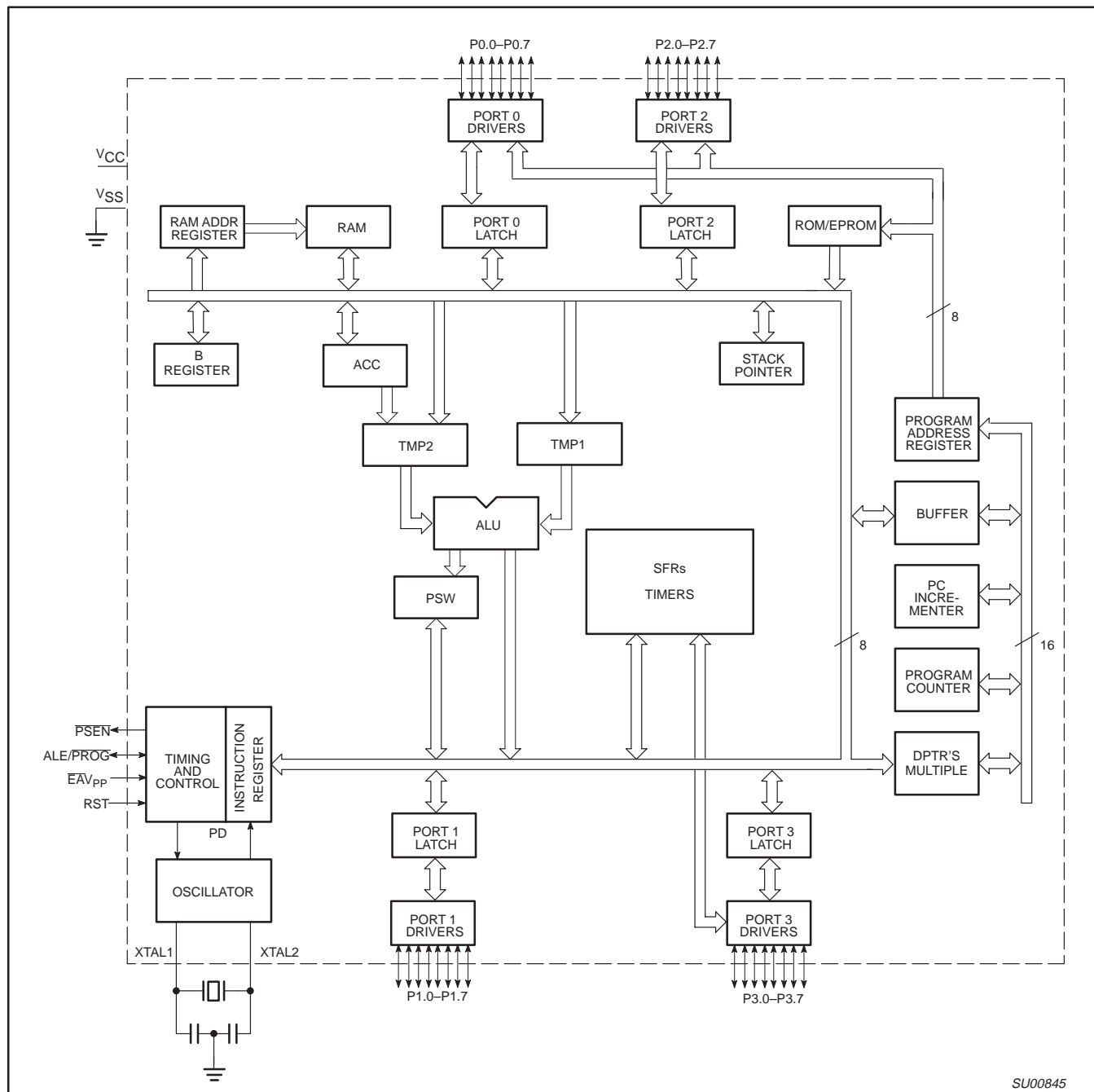
FEATURES

- 8051 Central Processing Unit
 - 128×8 RAM (80C31)
 - 256×8 RAM (80C32)
 - Three 16-bit counter/timers
 - Boolean processor
 - Full static operation
 - Low voltage (2.7 V to 5.5 V@ 16 MHz) operation
- Memory addressing capability
 - 64k ROM and 64k RAM
- Power control modes:
 - Clock can be stopped and resumed
 - Idle mode
 - Power-down mode
- CMOS and TTL compatible
- TWO speed ranges at $V_{CC} = 5$ V
 - 0 to 16 MHz
 - 0 to 33 MHz
- Three package styles
- Extended temperature ranges
- Dual Data Pointers
- 4 level priority interrupt
- 6 interrupt sources
- Four 8-bit I/O ports
- Full-duplex enhanced UART
 - Framing error detection
 - Automatic address recognition
- Programmable clock out
- Asynchronous port reset
- Low EMI (inhibit ALE)
- Wake-up from Power Down by an external interrupt

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BLOCK DIAGRAM

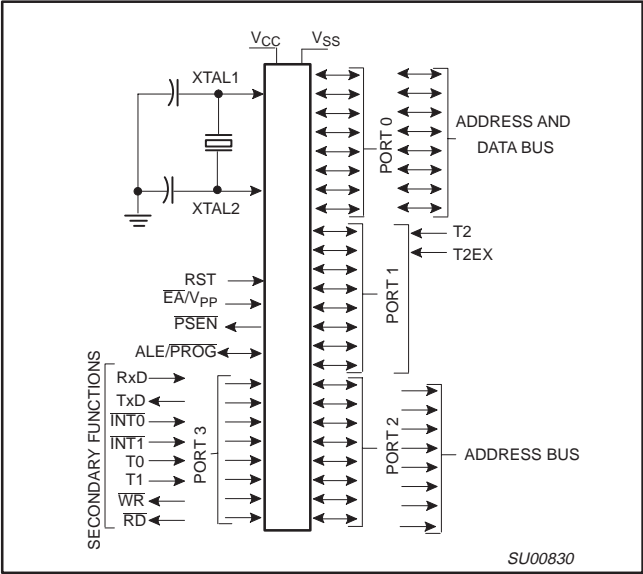


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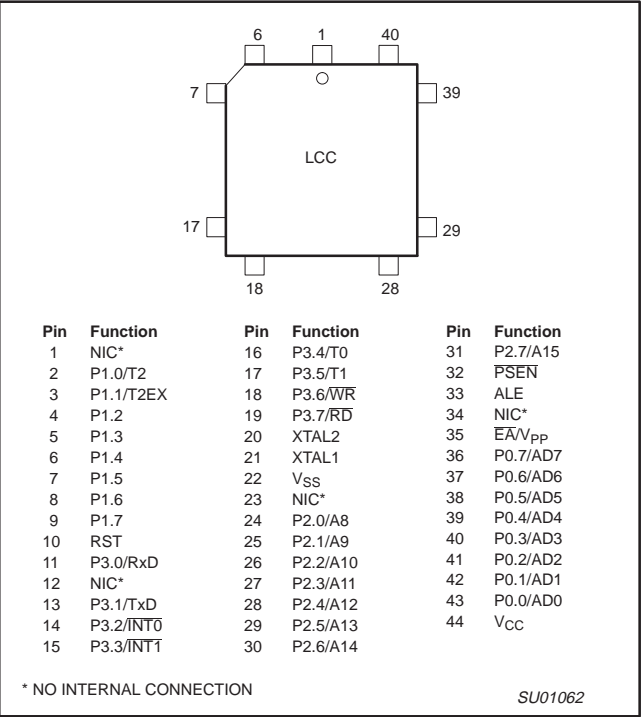
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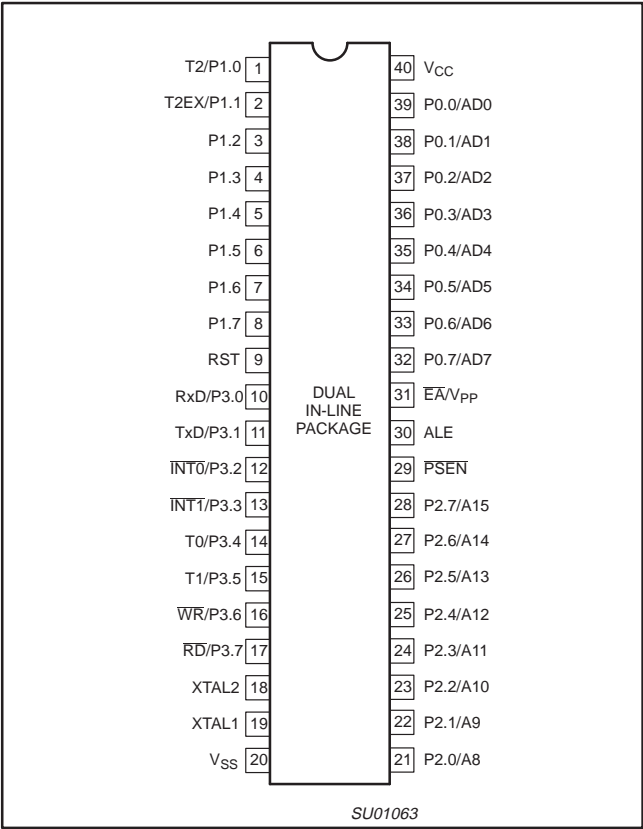
LOGIC SYMBOL



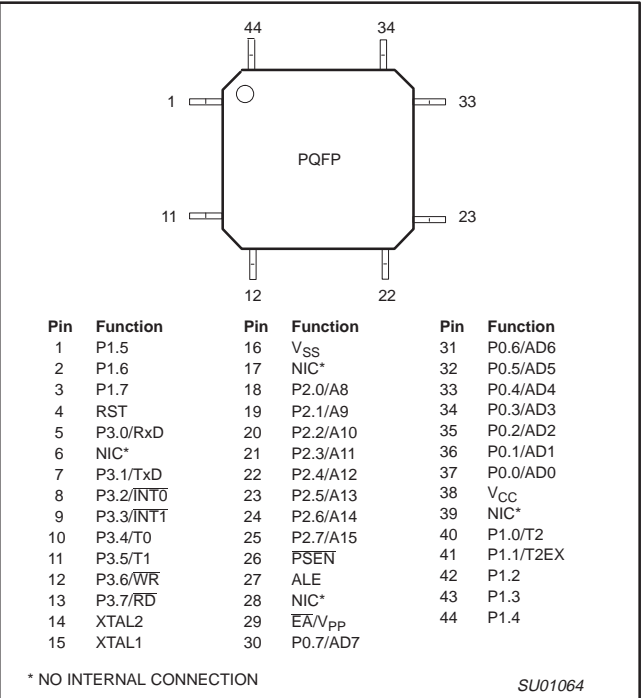
PLASTIC LEADED CHIP CARRIER PIN FUNCTIONS



PIN CONFIGURATIONS



PLASTIC QUAD FLAT PACK
PIN FUNCTIONS



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PIN DESCRIPTIONS

MNEMONIC	PIN NUMBER			TYPE	NAME AND FUNCTION
	DIP	LCC	QFP		
V _{SS}	20	22	16	I	Ground: 0 V reference.
V _{CC}	40	44	38	I	Power Supply: This is the power supply voltage for normal, idle, and power-down operation.
P0.0–P0.7	39–32	43–36	37–30	I/O	Port 0: Port 0 is an open-drain, bidirectional I/O port with Schmitt trigger inputs. Port 0 pins that have 1s written to them float and can be used as high-impedance inputs. Port 0 is also the multiplexed low-order address and data bus during accesses to external program and data memory. In this application, it uses strong internal pull-ups when emitting 1s.
P1.0–P1.7	1–8	2–9	40–44, 1–3	I/O	Port 1: Port 1 is an 8-bit bidirectional I/O port with internal pull-ups and Schmitt trigger inputs. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 1 pins that are externally pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I _{IL}). Alternate functions for Port 1 include: T2 (P1.0): Timer/Counter 2 external count input/clockout (see Programmable Clock-Out) T2EX (P1.1): Timer/Counter 2 Reload/Capture/Direction control
P2.0–P2.7	21–28	24–31	18–25	I/O	Port 2: Port 2 is an 8-bit bidirectional I/O port with internal pull-ups and Schmitt trigger inputs. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 2 pins that are externally being pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups when emitting 1s. During accesses to external data memory that use 8-bit addresses (MOV @Ri), port 2 emits the contents of the P2 special function register.
P3.0–P3.7	10–17	11, 13–19	5, 7–13	I/O	Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pull-ups and Schmitt trigger inputs. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 3 pins that are externally being pulled low will source current because of the pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 3 also serves the special features of the 80C51 family, as listed below: RxD (P3.0): Serial input port TxD (P3.1): Serial output port INT0 (P3.2): External interrupt INT1 (P3.3): External interrupt T0 (P3.4): Timer 0 external input T1 (P3.5): Timer 1 external input WR (P3.6): External data memory write strobe RD (P3.7): External data memory read strobe
RST	9	10	4	I	Reset: A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to V _{SS} permits a power-on reset using only an external capacitor to V _{CC} .
ALE	30	33	27	O	Address Latch Enable: Output pulse for latching the low byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory. ALE can be disabled by setting SFR auxiliary.0. With this bit set, ALE will be active only during a MOVX instruction.
PSEN	29	32	26	O	Program Store Enable: The read strobe to external program memory. When the 80C31/32 is executing code from the external program memory, PSEN is activated twice each machine cycle, except that two PSEN activations are skipped during each access to external data memory. PSEN is not activated during fetches from internal program memory.
E _A /V _{PP}	31	35	29	I	External Access Enable/Programming Supply Voltage: E _A must be externally held low to enable the device to fetch code from external program memory locations 0000H to 0FFFH.
XTAL1	19	21	15	I	Crystal 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTAL2	18	20	14	O	Crystal 2: Output from the inverting oscillator amplifier.

NOTE:

To avoid "latch-up" effect at power-on, the voltage on any pin at any time must not be higher than V_{CC} + 0.5 V or V_{SS} – 0.5 V, respectively.

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Table 1. 8XC51/80C31 Special Function Registers

SYMBOL	DESCRIPTION	DIRECT ADDRESS	BIT ADDRESS, SYMBOL, OR ALTERNATIVE PORT FUNCTION								RESET VALUE	
			MSB				LSB					
ACC*	Accumulator	E0H	E7	E6	E5	E4	E3	E2	E1	E0	00H	
AUXR#	Auxiliary	8EH	—	—	—	—	—	—	—	AO	xxxxxxx0B	
AUXR1#	Auxiliary 1	A2H	—	—	—	—	WUPD ²	0	—	DPS	xxx000x0B	
B*	B register	F0H	F7	F6	F5	F4	F3	F2	F1	F0	00H	
DPTR: DPH DPL	Data Pointer (2 bytes)											
	Data Pointer High	83H									00H	
	Data Pointer Low	82H									00H	
IE*	Interrupt Enable	A8H	AF	AE	AD	AC	AB	AA	A9	A8		
			EA	—	ET2	ES	ET1	EX1	ET0	EX0	0x000000B	
			BF	BE	BD	BC	BB	BA	B9	B8		
IP*	Interrupt Priority	B8H	—	—	PT2	PS	PT1	PX1	PT0	PX0	xx000000B	
			B7	B6	B5	B4	B3	B2	B1	B0		
IPH#	Interrupt Priority High	B7H	—	—	PT2H	PSH	PT1H	PX1H	PT0H	PX0H	xx000000B	
			87	86	85	84	83	82	81	80		
P0*	Port 0	80H	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	FFH	
			97	96	95	94	93	92	91	90		
P1*	Port 1	90H	—	—	—	—	—	—	T2EX	T2	FFH	
			A7	A6	A5	A4	A3	A2	A1	A0		
P2*	Port 2	A0H	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8	FFH	
			B7	B6	B5	B4	B3	B2	B1	B0		
P3*	Port 3	B0H	RD	WR	T1	T0	INT1	INT0	TxD	RxD	FFH	
PCON# ¹	Power Control	87H	SMOD1	SMOD0	—	POF	GF1	GF0	PD	IDL	00xx0000B	
			D7	D6	D5	D4	D3	D2	D1	D0		
PSW*	Program Status Word	D0H	CY	AC	F0	RS1	RS0	OV	—	P	000000x0B	
RACAP2H#	Timer 2 Capture High	CBH									00H	
RACAP2L#	Timer 2 Capture Low	CAH									00H	
SADDR#	Slave Address	A9H									00H	
SADEN#	Slave Address Mask	B9H									00H	
SBUF	Serial Data Buffer	99H									xxxxxxx0B	
SCON*	Serial Control	98H	9F	9E	9D	9C	9B	9A	99	98		
			SM0/FE	SM1	SM2	REN	TB8	RB8	T1	R1	00H	
SP	Stack Pointer	81H	8F	8E	8D	8C	8B	8A	89	88	07H	
TCON*	Timer Control	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0	00H	
			CF	CE	CD	CC	CB	CA	C9	C8		
T2CON*	Timer 2 Control	C8H	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2	00H	
T2MOD#	Timer 2 Mode Control	C9H	—	—	—	—	—	—	T2OE	DCEN	xxxxxx00B	
TH0	Timer High 0	8CH									00H	
TH1	Timer High 1	8DH									00H	
TH2#	Timer High 2	CDH									00H	
TL0	Timer Low 0	8AH									00H	
TL1	Timer Low 1	8BH									00H	
TL2#	Timer Low 2	CCH									00H	
TMOD	Timer Mode	89H	GATE	C/T	M1	M0	GATE	C/T	M1	M0	00H	

NOTE:

Unused register bits that are not defined should not be set by the user's program. If violated, the device could function incorrectly.

* SFRs are bit addressable.

SFRs are modified from or added to the 80C51 SFRs.

– Reserved bits.

1. Reset value depends on reset source.

2. Not available on 80C31.

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80C31/80C32

OSCILLATOR CHARACTERISTICS

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier. The pins can be configured for use as an on-chip oscillator, as shown in the logic symbol.

To drive the device from an external clock source, XTAL1 should be driven while XTAL2 is left unconnected. There are no requirements on the duty cycle of the external clock signal, because the input to the internal clock circuitry is through a divide-by-two flip-flop. However, minimum and maximum high and low times specified in the data sheet must be observed.

Reset

A reset is accomplished by holding the RST pin high for at least two machine cycles (24 oscillator periods), while the oscillator is running. To insure a good power-up reset, the RST pin must be high long enough to allow the oscillator time to start up (normally a few milliseconds) plus two machine cycles.

Stop Clock Mode

The static design enables the clock speed to be reduced down to 0 MHz (stopped). When the oscillator is stopped, the RAM and Special Function Registers retain their values. This mode allows step-by-step utilization and permits reduced system power consumption by lowering the clock frequency down to any value. For lowest power consumption the Power Down mode is suggested.

Idle Mode

In idle mode (see Table 2), the CPU puts itself to sleep while all of the on-chip peripherals stay active. The instruction to invoke the idle mode is the last instruction executed in the normal operating mode before the idle mode is activated. The CPU contents, the on-chip RAM, and all of the special function registers remain intact during this mode. The idle mode can be terminated either by any enabled interrupt (at which time the process is picked up at the interrupt service routine and continued), or by a hardware reset which starts the processor in the same manner as a power-on reset.

Power-Down Mode

To save even more power, a Power Down mode (see Table 2) can be invoked by software. In this mode, the oscillator is stopped and the instruction that invoked Power Down is the last instruction executed. The on-chip RAM and Special Function Registers retain their values down to 2.0 V and care must be taken to return V_{CC} to the minimum specified operating voltages before the Power Down Mode is terminated.

For the 80C31 or 80C32, either a hardware reset or external interrupt can be used to exit from Power Down. Reset redefines all the SFRs but does not change the on-chip RAM. An external interrupt allows both the SFRs and the on-chip RAM to retain their values. WUPD (AUXR1.3–Wakeup from Power Down) enables or disables the wakeup from power down with external interrupt. Where:

WUPD = 0 Disable

WUPD = 1 Enable

To properly terminate Power Down the reset or external interrupt should not be executed before V_{CC} is restored to its normal operating level and must be held active long enough for the oscillator to restart and stabilize (normally less than 10 ms).

With an external interrupt, INT0 or INT1 must be enabled and configured as level-sensitive. Holding the pin low restarts the oscillator but bringing the pin back high completes the exit. Once the interrupt is serviced, the next instruction to be executed after RETI will be the one following the instruction that put the device into Power Down.

For the 80C31, wakeup from power down is always enabled.

Design Consideration

- When the idle mode is terminated by a hardware reset, the device normally resumes program execution, from where it left off, up to two machine cycles before the internal reset algorithm takes control. On-chip hardware inhibits access to internal RAM in this event, but access to the port pins is not inhibited. To eliminate the possibility of an unexpected write when Idle is terminated by reset, the instruction following the one that invokes Idle should not be one that writes to a port pin or to external memory.

ONCE™ Mode

The ONCE ("On-Circuit Emulation") Mode facilitates testing and debugging of systems without the device having to be removed from the circuit. The ONCE Mode is invoked by:

- Pull ALE low while the device is in reset and \overline{PSEN} is high;
- Hold ALE low as RST is deactivated.

While the device is in ONCE Mode, the Port 0 pins go into a float state, and the other port pins and ALE and \overline{PSEN} are weakly pulled high. The oscillator circuit remains active. While the 80C31/32 is in this mode, an emulator or test CPU can be used to drive the circuit. Normal operation is restored when a normal reset is applied.

Table 2. External Pin Status During Idle and Power-Down Modes

MODE	PROGRAM MEMORY	ALE	\overline{PSEN}	PORT 0	PORT 1	PORT 2	PORT 3
Idle	Internal	1	1	Data	Data	Data	Data
Idle	External	1	1	Float	Data	Address	Data
Power-down	Internal	0	0	Data	Data	Data	Data
Power-down	External	0	0	Float	Data	Data	Data

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Programmable Clock-Out

A 50% duty cycle clock can be programmed to come out on P1.0. This pin, besides being a regular I/O pin, has two alternate functions. It can be programmed:

1. to input the external clock for Timer/Counter 2, or
2. to output a 50% duty cycle clock ranging from 61 Hz to 4 MHz at a 16 MHz operating frequency.

To configure the Timer/Counter 2 as a clock generator, bit C/T2 (in T2CON) must be cleared and bit T2OE in T2MOD must be set. Bit TR2 (T2CON.2) also must be set to start the timer.

The Clock-Out frequency depends on the oscillator frequency and the reload value of Timer 2 capture registers (RCAP2H, RCAP2L) as shown in this equation:

$$\frac{\text{Oscillator Frequency}}{4 \times (65536 - \text{RCAP2H, RCAP2L})}$$

Where:

(RCAP2H, RCAP2L) = the content of RCAP2H and RCAP2L taken as a 16-bit unsigned integer.

In the Clock-Out mode Timer 2 roll-overs will not generate an interrupt. This is similar to when it is used as a baud-rate generator. It is possible to use Timer 2 as a baud-rate generator and a clock generator simultaneously. Note, however, that the baud-rate and the Clock-Out frequency will be the same.

TIMER 2 OPERATION

Timer 2

Timer 2 is a 16-bit Timer/Counter which can operate as either an event timer or an event counter, as selected by C/T2* in the special function register T2CON (see Figure 1). Timer 2 has three operating modes: Capture, Auto-reload (up or down counting), and Baud Rate Generator, which are selected by bits in the T2CON as shown in Table 3.

Capture Mode

In the capture mode there are two options which are selected by bit EXEN2 in T2CON. If EXEN2=0, then timer 2 is a 16-bit timer or counter (as selected by C/T2* in T2CON) which, upon overflowing sets bit TF2, the timer 2 overflow bit. This bit can be used to generate an interrupt (by enabling the Timer 2 interrupt bit in the IE register). If EXEN2= 1, Timer 2 operates as described above, but with the added feature that a 1- to -0 transition at external input T2EX causes the current value in the Timer 2 registers, TL2 and

TH2, to be captured into registers RCAP2L and RCAP2H, respectively. In addition, the transition at T2EX causes bit EXF2 in T2CON to be set, and EXF2 like TF2 can generate an interrupt (which vectors to the same location as Timer 2 overflow interrupt. The Timer 2 interrupt service routine can interrogate TF2 and EXF2 to determine which event caused the interrupt). The capture mode is illustrated in Figure 2 (There is no reload value for TL2 and TH2 in this mode. Even when a capture event occurs from T2EX, the counter keeps on counting T2EX pin transitions or osc/12 pulses.).

Auto-Reload Mode (Up or Down Counter)

In the 16-bit auto-reload mode, Timer 2 can be configured (as either a timer or counter (C/T2* in T2CON)) then programmed to count up or down. The counting direction is determined by bit DCEN (Down Counter Enable) which is located in the T2MOD register (see Figure 3). When reset is applied the DCEN=0 which means Timer 2 will default to counting up. If DCEN bit is set, Timer 2 can count up or down depending on the value of the T2EX pin.

Figure 4 shows Timer 2 which will count up automatically since DCEN=0. In this mode there are two options selected by bit EXEN2 in T2CON register. If EXEN2=0, then Timer 2 counts up to 0FFFFH and sets the TF2 (Overflow Flag) bit upon overflow. This causes the Timer 2 registers to be reloaded with the 16-bit value in RCAP2L and RCAP2H. The values in RCAP2L and RCAP2H are preset by software means.

If EXEN2=1, then a 16-bit reload can be triggered either by an overflow or by a 1-to-0 transition at input T2EX. This transition also sets the EXF2 bit. The Timer 2 interrupt, if enabled, can be generated when either TF2 or EXF2 are 1.

In Figure 5 DCEN=1 which enables Timer 2 to count up or down. This mode allows pin T2EX to control the direction of count. When a logic 1 is applied at pin T2EX Timer 2 will count up. Timer 2 will overflow at 0FFFFH and set the TF2 flag, which can then generate an interrupt, if the interrupt is enabled. This timer overflow also causes the 16-bit value in RCAP2L and RCAP2H to be reloaded into the timer registers TL2 and TH2.

When a logic 0 is applied at pin T2EX this causes Timer 2 to count down. The timer will underflow when TL2 and TH2 become equal to the value stored in RCAP2L and RCAP2H. Timer 2 underflow sets the TF2 flag and causes 0FFFFH to be reloaded into the timer registers TL2 and TH2.

The external flag EXF2 toggles when Timer 2 underflows or overflows. This EXF2 bit can be used as a 17th bit of resolution if needed. The EXF2 flag does not generate an interrupt in this mode of operation.

Table 3. Timer 2 Operating Modes

RCLK + TCLK	CP/RL2	TR2	MODE
0	0	1	16-bit Auto-reload
0	1	1	16-bit Capture
1	X	1	Baud rate generator
X	X	0	(off)

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(MSB)				(LSB)			
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/ $\overline{T2}$	CP/ $\overline{RL2}$

Symbol	Position	Name and Significance
TF2	T2CON.7	Timer 2 overflow flag set by a Timer 2 overflow and must be cleared by software. TF2 will not be set when either RCLK or TCLK = 1.
EXF2	T2CON.6	Timer 2 external flag set when either a capture or reload is caused by a negative transition on T2EX and EXEN2 = 1. When Timer 2 interrupt is enabled, EXF2 = 1 will cause the CPU to vector to the Timer 2 interrupt routine. EXF2 must be cleared by software. EXF2 does not cause an interrupt in up/down counter mode (DCEN = 1).
RCLK	T2CON.5	Receive clock flag. When set, causes the serial port to use Timer 2 overflow pulses for its receive clock in modes 1 and 3. RCLK = 0 causes Timer 1 overflow to be used for the receive clock.
TCLK	T2CON.4	Transmit clock flag. When set, causes the serial port to use Timer 2 overflow pulses for its transmit clock in modes 1 and 3. TCLK = 0 causes Timer 1 overflows to be used for the transmit clock.
EXEN2	T2CON.3	Timer 2 external enable flag. When set, allows a capture or reload to occur as a result of a negative transition on T2EX if Timer 2 is not being used to clock the serial port. EXEN2 = 0 causes Timer 2 to ignore events at T2EX.
TR2	T2CON.2	Start/stop control for Timer 2. A logic 1 starts the timer.
C/ $\overline{T2}$	T2CON.1	Timer or counter select. (Timer 2) 0 = Internal timer (OSC/12) 1 = External event counter (falling edge triggered).
CP/ $\overline{RL2}$	T2CON.0	Capture/Reload flag. When set, captures will occur on negative transitions at T2EX if EXEN2 = 1. When cleared, auto-reloads will occur either with Timer 2 overflows or negative transitions at T2EX when EXEN2 = 1. When either RCLK = 1 or TCLK = 1, this bit is ignored and the timer is forced to auto-reload on Timer 2 overflow.

Figure 1. Timer/Counter 2 (T2CON) Control Register

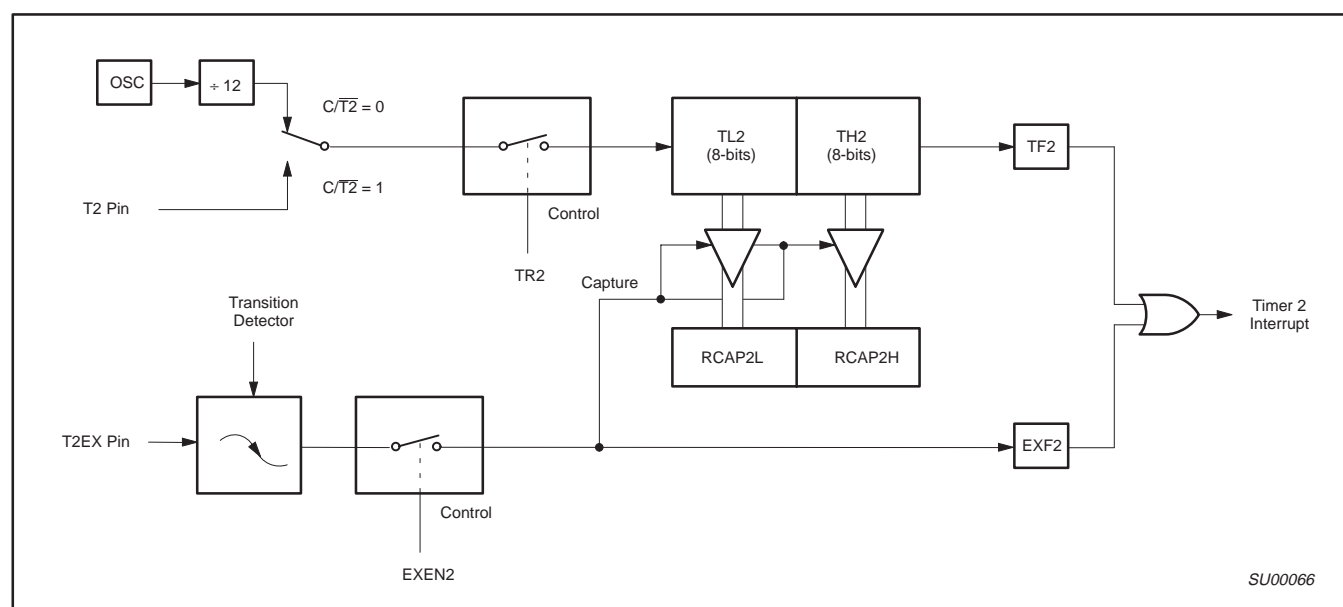


Figure 2. Timer 2 in Capture Mode

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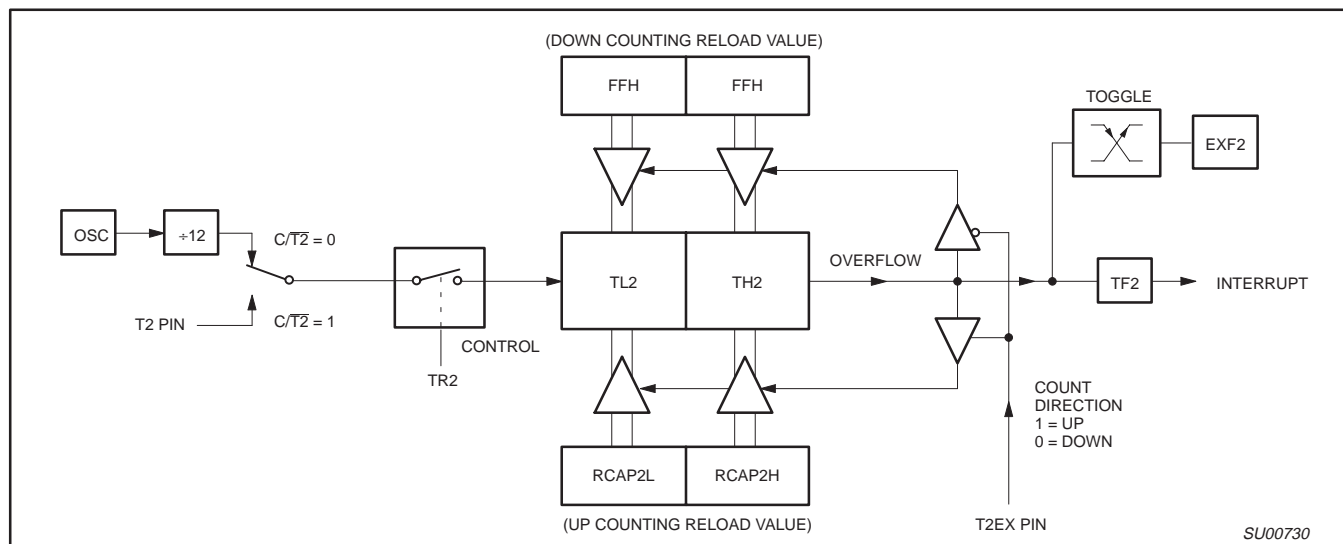


Figure 5. Timer 2 Auto Reload Mode (DCEN = 1)

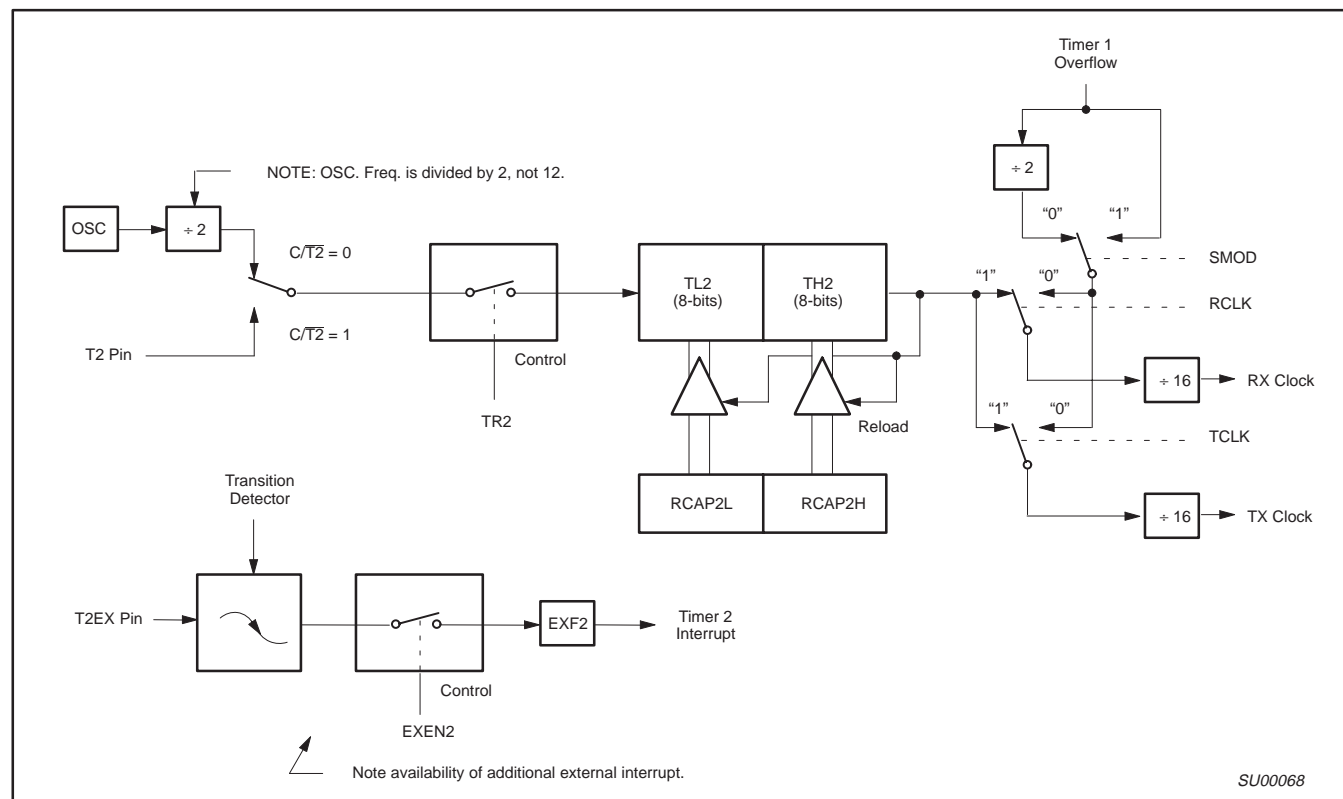


Figure 6. Timer 2 in Baud Rate Generator Mode

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80C31/80C32

Interrupt Priority Structure

The 80C31 and 80C32 have a 6-source four-level interrupt structure. They are the IE, IP and IPH. (See Figures 10, 11, and 12.) The IPH (Interrupt Priority High) register that makes the four-level interrupt structure possible. The IPH is located at SFR address B7H. The structure of the IPH register and a description of its bits is shown in Figure 12.

The function of the IPH SFR is simple and when combined with the IP SFR determines the priority of each interrupt. The priority of each interrupt is determined as shown in the following table:

PRIORITY BITS		INTERRUPT PRIORITY LEVEL
IPH.x	IP.x	
0	0	Level 0 (lowest priority)
0	1	Level 1
1	0	Level 2
1	1	Level 3 (highest priority)

An interrupt will be serviced as long as an interrupt of equal or higher priority is not already being serviced. If an interrupt of equal or higher level priority is being serviced, the new interrupt will wait until it is finished before being serviced. If a lower priority level interrupt is being serviced, it will be stopped and the new interrupt serviced. When the new interrupt is finished, the lower priority level interrupt that was stopped will be completed.

Table 7. Interrupt Table

SOURCE	POLLING PRIORITY	REQUEST BITS	HARDWARE CLEAR?	VECTOR ADDRESS
X0	1	IE0	N (L) ¹ Y (T) ²	03H
T0	2	TP0	Y	0BH
X1	3	IE1	N (L) Y (T)	13H
T1	4	TF1	Y	1BH
SP	5	RI, TI	N	23H
T2	6	TF2, EXF2	N	2BH

NOTES:

1. L = Level activated
2. T = Transition activated

		7	6	5	4	3	2	1	0
IE (0A8H)		EA	—	ET2	ES	ET1	EX1	ET0	EX0
		Enable Bit = 1 enables the interrupt. Enable Bit = 0 disables it.							
BIT	SYMBOL	FUNCTION							
IE.7	EA	Global disable bit. If EA = 0, all interrupts are disabled. If EA = 1, each interrupt can be individually enabled or disabled by setting or clearing its enable bit.							
IE.6	—	Not implemented. Reserved for future use.							
IE.5	ET2	Timer 2 interrupt enable bit.							
IE.4	ES	Serial Port interrupt enable bit.							
IE.3	ET1	Timer 1 interrupt enable bit.							
IE.2	EX1	External interrupt 1 enable bit.							
IE.1	ET0	Timer 0 interrupt enable bit.							
IE.0	EX0	External interrupt 0 enable bit.							

SU00571

Figure 10. IE Registers

80C51 8-bit microcontroller family
 128/256 byte RAM ROMless low voltage (2.7V–5.5V),
 low power, high speed (33 MHz)

80C31/80C32

		7	6	5	4	3	2	1	0
IP (0B8H)		—	—	PT2	PS	PT1	PX1	PT0	PX0
		Priority Bit = 1 assigns higher priority Priority Bit = 0 assigns lower priority							
BIT	SYMBOL	FUNCTION							
IP.7	—	Not implemented, reserved for future use.							
IP.6	—	Not implemented, reserved for future use.							
IP.5	PT2	Timer 2 interrupt priority bit.							
IP.4	PS	Serial Port interrupt priority bit.							
IP.3	PT1	Timer 1 interrupt priority bit.							
IP.2	PX1	External interrupt 1 priority bit.							
IP.1	PT0	Timer 0 interrupt priority bit.							
IP.0	PX0	External interrupt 0 priority bit.							

SU00572

Figure 11. IP Registers

		7	6	5	4	3	2	1	0
IPH (B7H)		—	—	PT2H	PSH	PT1H	PX1H	PT0H	PX0H
		Priority Bit = 1 assigns higher priority Priority Bit = 0 assigns lower priority							
BIT	SYMBOL	FUNCTION							
IPH.7	—	Not implemented, reserved for future use.							
IPH.6	—	Not implemented, reserved for future use.							
IPH.5	PT2H	Timer 2 interrupt priority bit high.							
IPH.4	PSH	Serial Port interrupt priority bit high.							
IPH.3	PT1H	Timer 1 interrupt priority bit high.							
IPH.2	PX1H	External interrupt 1 priority bit high.							
IPH.1	PT0H	Timer 0 interrupt priority bit high.							
IPH.0	PX0H	External interrupt 0 priority bit high.							

SU01058

Figure 12. IPH Registers

80C51 8-bit microcontroller family
 128/256 byte RAM ROMless low voltage (2.7V–5.5V),
 low power, high speed (33 MHz)

80C31/80C32

DC ELECTRICAL CHARACTERISTICS

$T_{amb} = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$ or -40°C to $+85^{\circ}\text{C}$, $V_{CC} = 2.7\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$ (16 MHz devices)

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP ¹	MAX	
V_{IL}	Input low voltage	$4.0\text{ V} < V_{CC} < 5.5\text{ V}$	-0.5		$0.2 V_{CC} - 0.1$	V
		$2.7\text{ V} < V_{CC} < 4.0\text{ V}$	-0.5		0.7	V
V_{IH}	Input high voltage (ports 0, 1, 2, 3, EA)		$0.2 V_{CC} + 0.9$		$V_{CC} + 0.5$	V
V_{IH1}	Input high voltage, XTAL1, RST		$0.7 V_{CC}$		$V_{CC} + 0.5$	V
V_{OL}	Output low voltage, ports 1, 2, ⁸	$V_{CC} = 2.7\text{ V}$ $I_{OL} = 1.6\text{ mA}^2$			0.4	V
V_{OL1}	Output low voltage, port 0, ALE, $\overline{\text{PSEN}}^8, 7$	$V_{CC} = 2.7\text{ V}$ $I_{OL} = 3.2\text{ mA}^2$			0.4	V
V_{OH}	Output high voltage, ports 1, 2, 3 ³	$V_{CC} = 2.7\text{ V}$ $I_{OH} = -20\text{ }\mu\text{A}$	$V_{CC} - 0.7$			V
		$V_{CC} = 4.5\text{ V}$ $I_{OH} = -30\text{ }\mu\text{A}$	$V_{CC} - 0.7$			V
V_{OH1}	Output high voltage (port 0 in external bus mode), ALE ⁹ , $\overline{\text{PSEN}}^3$	$V_{CC} = 2.7\text{ V}$ $I_{OH} = -3.2\text{ mA}$	$V_{CC} - 0.7$			V
I_{IL}	Logical 0 input current, ports 1, 2, 3	$V_{IN} = 0.4\text{ V}$	-1		-50	μA
I_{TL}	Logical 1-to-0 transition current, ports 1, 2, 3 ⁶	$V_{IN} = 2.0\text{ V}$ See note 4			-650	μA
I_{LI}	Input leakage current, port 0	$0.45 < V_{IN} < V_{CC} - 0.3$			± 10	μA
I_{CC}	Power supply current (see Figure 21): Active mode @ 16 MHz Idle mode @ 16 MHz Power-down mode or clock stopped (see Figure 25 for conditions)	See note 5 $T_{amb} = 0^{\circ}\text{C}$ to 70°C $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$		3		μA
					50 75	μA μA
R_{RST}	Internal reset pull-down resistor		40		225	k Ω
C_{IO}	Pin capacitance ¹⁰ (except EA)				15	pF

NOTES:

- Typical ratings are not guaranteed. The values listed are at room temperature, 5 V.
- Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the V_{OL} s of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading $> 100\text{ pF}$), the noise pulse on the ALE pin may exceed 0.8 V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. I_{OL} can exceed these conditions provided that no single output sinks more than 5 mA and no more than two outputs exceed the test conditions.
- Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and $\overline{\text{PSEN}}$ to momentarily fall below the $V_{CC} - 0.7$ specification when the address bits are stabilizing.
- Pins of ports 1, 2 and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2 V.
- See Figures 22 through 25 for I_{CC} test conditions.
Active mode: $I_{CC} = 0.9 \times \text{FREQ.} + 1.1\text{ mA}$
Idle mode: $I_{CC} = 0.18 \times \text{FREQ.} + 1.01\text{ mA}$; See Figure 21.
- This value applies to $T_{amb} = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$. For $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $I_{TL} = -750\text{ }\mu\text{A}$.
- Load capacitance for port 0, ALE, and $\overline{\text{PSEN}} = 100\text{ pF}$, load capacitance for all other outputs = 80 pF.
- Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
Maximum I_{OL} per port pin: 15 mA (*NOTE: This is 85°C specification.)
Maximum I_{OL} per 8-bit port: 26 mA
Maximum total I_{OL} for all outputs: 71 mA
If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.
- ALE is tested to V_{OH1} , except when ALE is off then V_{OH} is the voltage specification.
- Pin capacitance is characterized but not tested. Pin capacitance is less than 25 pF.

80C51 8-bit microcontroller family
 128/256 byte RAM ROMless low voltage (2.7V–5.5V),
 low power, high speed (33 MHz)

80C31/80C32

DC ELECTRICAL CHARACTERISTICS

$T_{amb} = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$ or -40°C to $+85^{\circ}\text{C}$, 33 MHz devices; 5 V $\pm 10\%$; $V_{SS} = 0$ V

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP ¹	MAX	
V_{IL}	Input low voltage	$4.5\text{ V} < V_{CC} < 5.5\text{ V}$	-0.5		$0.2 V_{CC} - 0.1$	V
V_{IH}	Input high voltage (ports 0, 1, 2, 3, $\overline{\text{EA}}$)		$0.2 V_{CC} + 0.9$		$V_{CC} + 0.5$	V
V_{IH1}	Input high voltage, XTAL1, RST		$0.7 V_{CC}$		$V_{CC} + 0.5$	V
V_{OL}	Output low voltage, ports 1, 2, 3 ⁸	$V_{CC} = 4.5\text{ V}$ $I_{OL} = 1.6\text{ mA}^2$			0.4	V
V_{OL1}	Output low voltage, port 0, ALE, $\overline{\text{PSEN}}$ ^{7, 8}	$V_{CC} = 4.5\text{ V}$ $I_{OL} = 3.2\text{ mA}^2$			0.4	V
V_{OH}	Output high voltage, ports 1, 2, 3 ³	$V_{CC} = 4.5\text{ V}$ $I_{OH} = -30\mu\text{A}$	$V_{CC} - 0.7$			V
V_{OH1}	Output high voltage (port 0 in external bus mode), ALE ⁹ , $\overline{\text{PSEN}}$ ³	$V_{CC} = 4.5\text{ V}$ $I_{OH} = -3.2\text{ mA}$	$V_{CC} - 0.7$			V
I_{IL}	Logical 0 input current, ports 1, 2, 3	$V_{IN} = 0.4\text{ V}$	-1		-50	μA
I_{TL}	Logical 1-to-0 transition current, ports 1, 2, 3 ⁶	$V_{IN} = 2.0\text{ V}$ See note 4			-650	μA
I_{LI}	Input leakage current, port 0	$0.45 < V_{IN} < V_{CC} - 0.3$			± 10	μA
I_{CC}	Power supply current (see Figure 21): Active mode (see Note 5) Idle mode (see Note 5) Power-down mode or clock stopped (see Figure 25 for conditions)	See note 5 $T_{amb} = 0^{\circ}\text{C}$ to 70°C $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$		3	50 75	μA μA
R_{RST}	Internal reset pull-down resistor		40		225	$\text{k}\Omega$
C_{IO}	Pin capacitance ¹⁰ (except $\overline{\text{EA}}$)				15	pF

NOTES:

- Typical ratings are not guaranteed. The values listed are at room temperature, 5 V.
- Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the V_{OL} s of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100 pF), the noise pulse on the ALE pin may exceed 0.8 V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. I_{OL} can exceed these conditions provided that no single output sinks more than 5mA and no more than two outputs exceed the test conditions.
- Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and $\overline{\text{PSEN}}$ to momentarily fall below the $V_{CC} - 0.7$ specification when the address bits are stabilizing.
- Pins of ports 1, 2 and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2 V.
- See Figures 22 through 25 for I_{CC} test conditions.
 Active mode: $I_{CC(\text{MAX})} = 0.9 \times \text{FREQ.} + 1.1\text{ mA}$
 Idle mode: $I_{CC(\text{MAX})} = 0.18 \times \text{FREQ.} + 1.0\text{ mA}$; See Figure 21.
- This value applies to $T_{amb} = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$. For $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $I_{TL} = -750\text{ }\mu\text{A}$.
- Load capacitance for port 0, ALE, and $\overline{\text{PSEN}} = 100$ pF, load capacitance for all other outputs = 80 pF.
- Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
 Maximum I_{OL} per port pin: 15 mA (*NOTE: This is 85°C specification.)
 Maximum I_{OL} per 8-bit port: 26 mA
 Maximum total I_{OL} for all outputs: 71 mA
 If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.
- ALE is tested to V_{OH1} , except when ALE is off then V_{OH} is the voltage specification.
- Pin capacitance is characterized but not tested. Pin capacitance is less than 25 pF. Pin capacitance of ceramic package is less than 15 pF (except $\overline{\text{EA}}$ is 25 pF).

80C51 8-bit microcontroller family
128/256 byte RAM ROMless low voltage (2.7V–5.5V),
low power, high speed (33 MHz)

80C31/80C32

AC ELECTRICAL CHARACTERISTICS

$T_{amb} = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$ or -40°C to $+85^{\circ}\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$ ^{1, 2, 3}

SYMBOL	FIGURE	PARAMETER	VARIABLE CLOCK ⁴ 16 MHz to f_{max}		33 MHz CLOCK		UNIT
			MIN	MAX	MIN	MAX	
t_{HLL}	14	ALE pulse width	$2t_{CLCL}-40$		21		ns
t_{AVLL}	14	Address valid to ALE low	$t_{CLCL}-25$		5		ns
t_{LLAX}	14	Address hold after ALE low	$t_{CLCL}-25$				ns
t_{LLIV}	14	ALE low to valid instruction in		$4t_{CLCL}-65$		55	ns
t_{LLPL}	14	ALE low to $\overline{\text{PSEN}}$ low	$t_{CLCL}-25$		5		ns
t_{PLPH}	14	$\overline{\text{PSEN}}$ pulse width	$3t_{CLCL}-45$		45		ns
t_{PLIV}	14	$\overline{\text{PSEN}}$ low to valid instruction in		$3t_{CLCL}-60$		30	ns
t_{PXIX}	14	Input instruction hold after $\overline{\text{PSEN}}$	0		0		ns
t_{PXIZ}	14	Input instruction float after $\overline{\text{PSEN}}$		$t_{CLCL}-25$		5	ns
t_{AVIV}	14	Address to valid instruction in		$5t_{CLCL}-80$		70	ns
t_{PLAZ}	14	$\overline{\text{PSEN}}$ low to address float		10		10	ns
Data Memory							
t_{RLRH}	15, 16	RD pulse width	$6t_{CLCL}-100$		82		ns
t_{WLWH}	15, 16	WR pulse width	$6t_{CLCL}-100$		82		ns
t_{RLDV}	15, 16	RD low to valid data in		$5t_{CLCL}-90$		60	ns
t_{RHDX}	15, 16	Data hold after RD	0		0		ns
t_{RHDZ}	15, 16	Data float after RD		$2t_{CLCL}-28$		32	ns
t_{LLDV}	15, 16	ALE low to valid data in		$8t_{CLCL}-150$		90	ns
t_{AVDV}	15, 16	Address to valid data in		$9t_{CLCL}-165$		105	ns
t_{LLWL}	15, 16	ALE low to RD or WR low	$3t_{CLCL}-50$	$3t_{CLCL}+50$	40	140	ns
t_{AVWL}	15, 16	Address valid to WR low or RD low	$4t_{CLCL}-75$		45		ns
t_{QVWX}	15, 16	Data valid to WR transition	$t_{CLCL}-30$		0		ns
t_{WHQX}	15, 16	Data hold after WR	$t_{CLCL}-25$		5		ns
t_{QVWH}	16	Data valid to WR high	$7t_{CLCL}-130$		80		ns
t_{RLAZ}	15, 16	RD low to address float		0		0	ns
t_{WHLH}	15, 16	RD or WR high to ALE high	$t_{CLCL}-25$	$t_{CLCL}+25$	5	55	ns
External Clock							
t_{CHCX}	18	High time	$0.38t_{CLCL}$	$t_{CLCL}-t_{CLCX}$			ns
t_{CLCX}	18	Low time	$0.38t_{CLCL}$	$t_{CLCL}-t_{CHCX}$			ns
t_{CLCH}	18	Rise time		5			ns
t_{CHCL}	18	Fall time		5			ns
Shift Register							
t_{XLXL}	17	Serial port clock cycle time	$12t_{CLCL}$		360		ns
t_{QVXH}	17	Output data setup to clock rising edge	$10t_{CLCL}-133$		167		ns
t_{XHGX}	17	Output data hold after clock rising edge	$2t_{CLCL}-80$				ns
t_{XHDX}	17	Input data hold after clock rising edge	0		0		ns
t_{XHDX}	17	Clock rising edge to input data valid		$10t_{CLCL}-133$		167	ns

NOTES:

- Parameters are valid over operating temperature range unless otherwise specified.
- Load capacitance for port 0, ALE, and $\overline{\text{PSEN}}$ = 100 pF, load capacitance for all other outputs = 80 pF.
- Interfacing the 80C31 and 80C32 to devices with float times up to 45ns is permitted. This limited bus contention will not cause damage to Port 0 drivers.
- Variable clock is specified for oscillator frequencies greater than 16 MHz to 33 MHz. For frequencies equal or less than 16 MHz, see 16 MHz "AC Electrical Characteristics", page 23.
- Parts are guaranteed to operate down to 0 Hz. When an external clock source is used, the RST pin should be held high for a minimum of 20 μs for power-on or wakeup from power down.

80C51 8-bit microcontroller family
128/256 byte RAM ROMless low voltage (2.7V–5.5V),
low power, high speed (33 MHz)

80C31/80C32

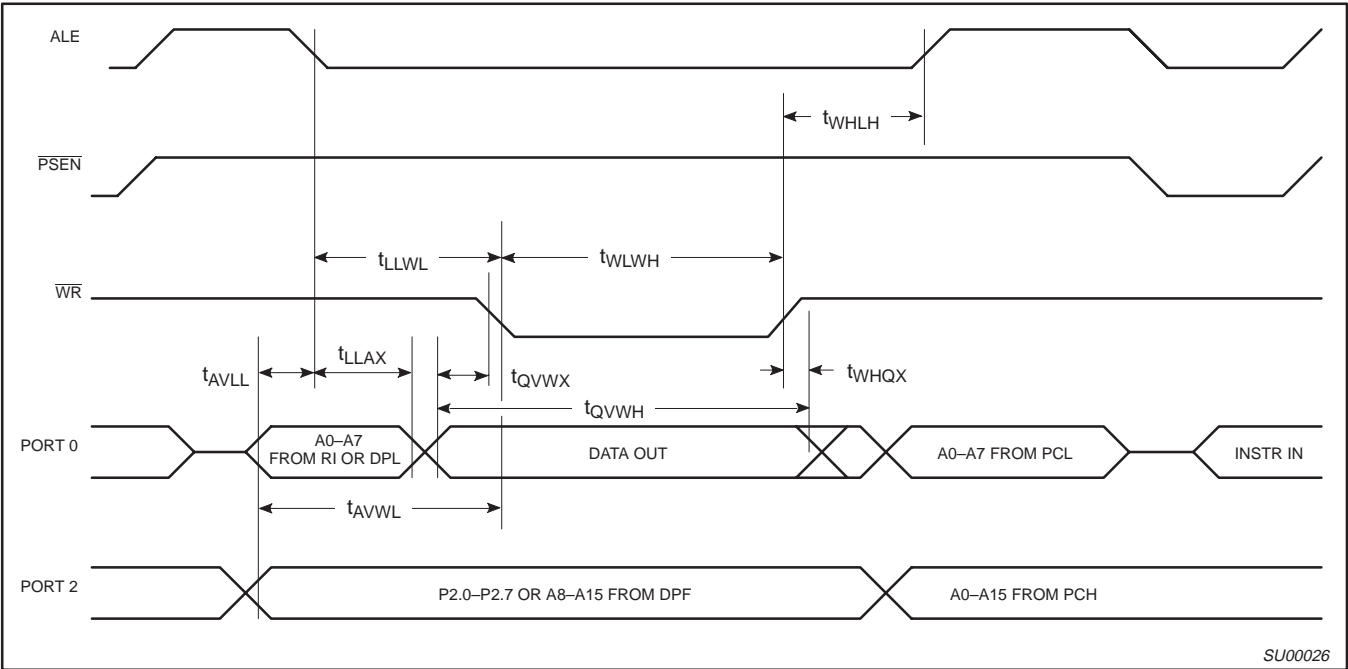


Figure 16. External Data Memory Write Cycle

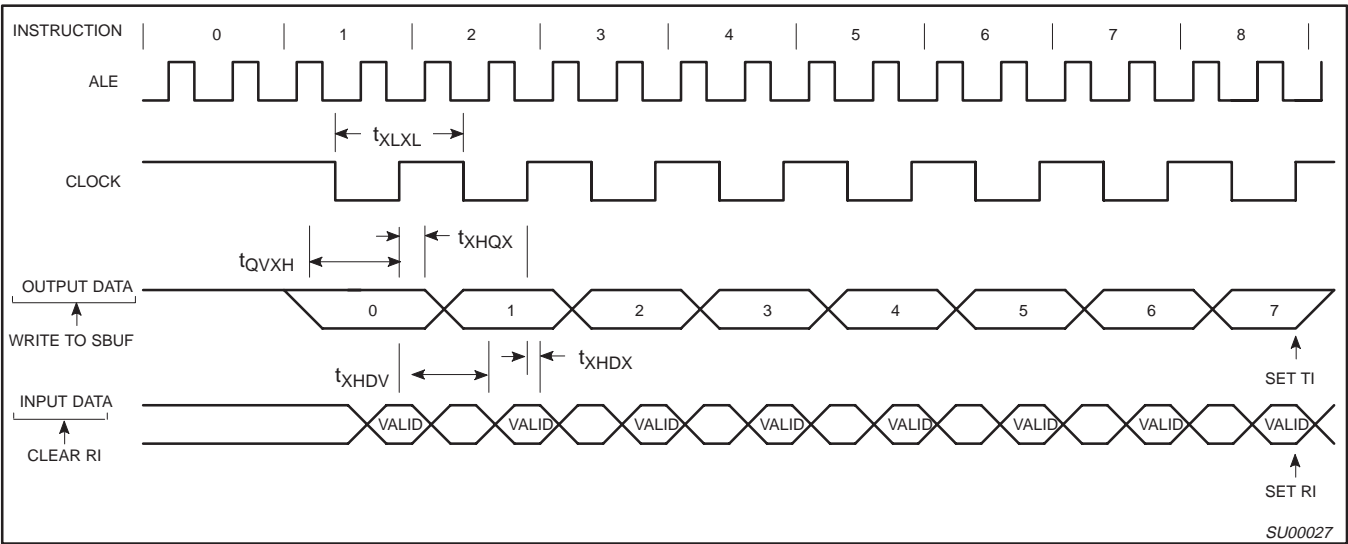


Figure 17. Shift Register Mode Timing

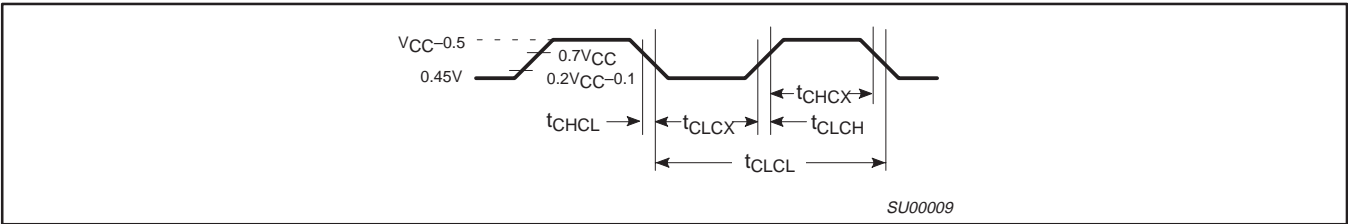


Figure 18. External Clock Drive

80C51 8-bit microcontroller family
128/256 byte RAM ROMless low voltage (2.7V–5.5V),
low power, high speed (33 MHz)

80C31/80C32

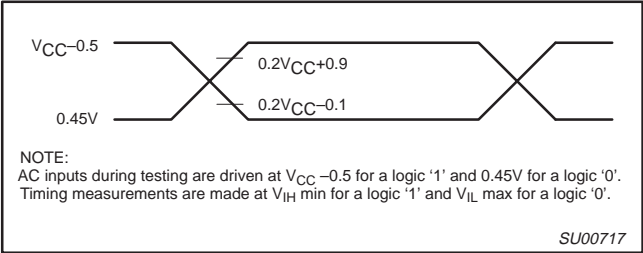


Figure 19. AC Testing Input/Output

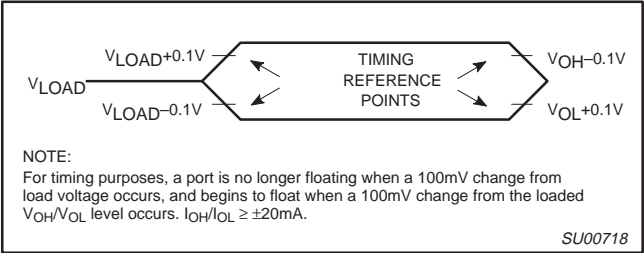


Figure 20. Float Waveform

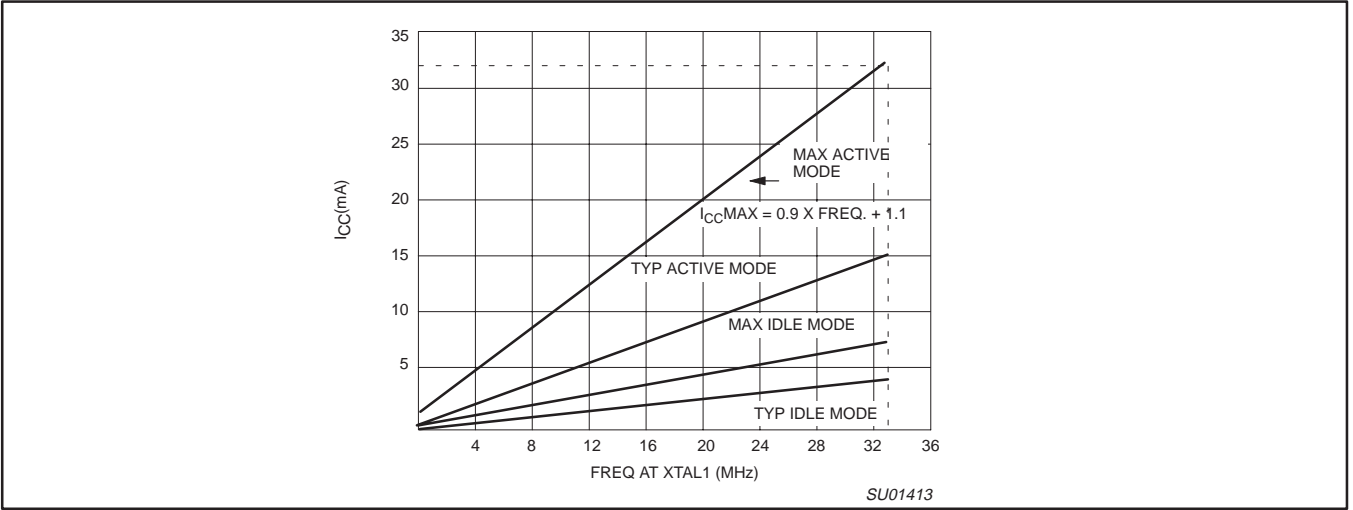


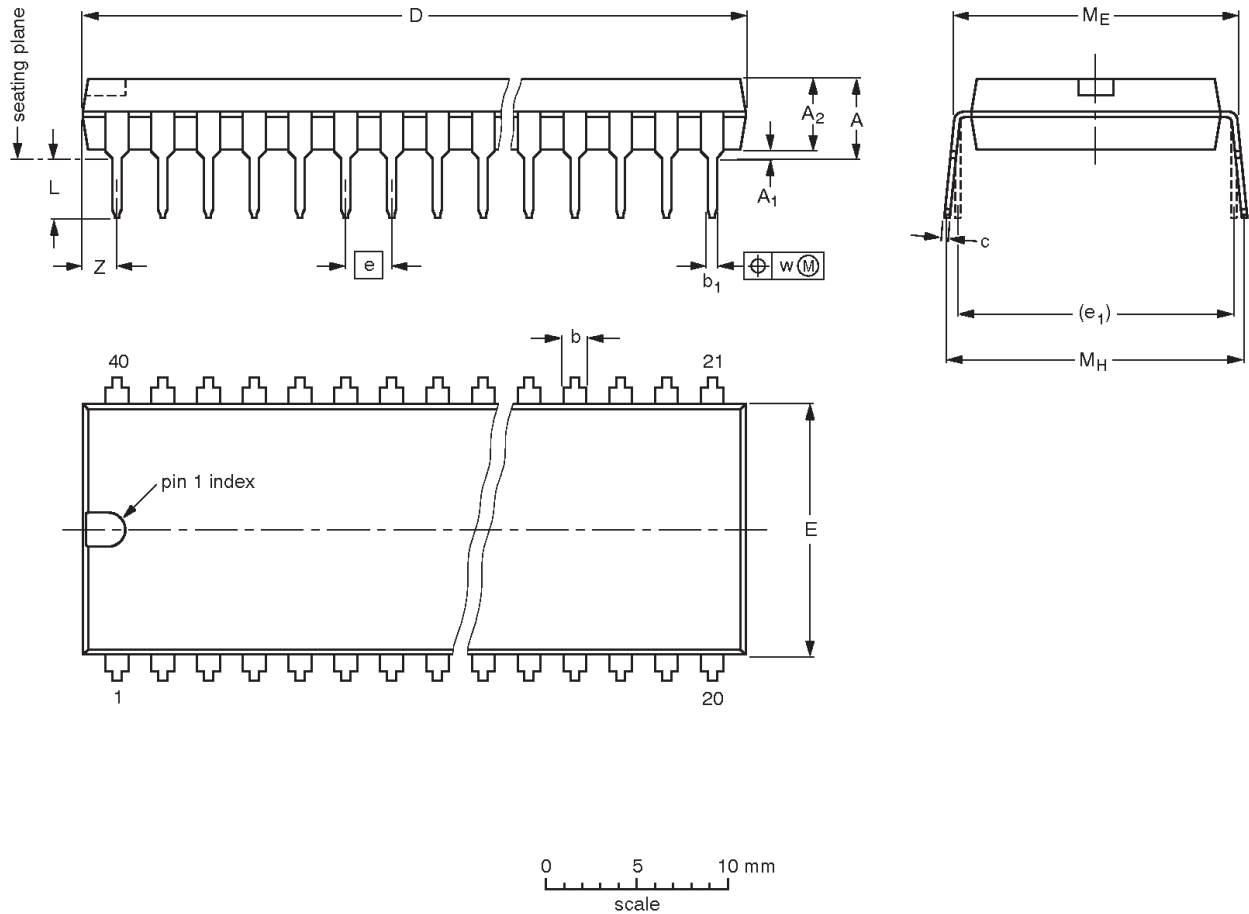
Figure 21. I_{CC} vs. FREQ
Valid only within frequency specifications of the device under test

80C51 8-bit microcontroller family
128/256 byte RAM ROMless low voltage (2.7V–5.5V),
low power, high speed (33 MHz)

80C31/80C32

DIP40: plastic dual in-line package; 40 leads (600 mil)

SOT129-1




DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.7	0.51	4.0	1.70 1.14	0.53 0.38	0.36 0.23	52.50 51.50	14.1 13.7	2.54	15.24	3.60 3.05	15.80 15.24	17.42 15.90	0.254	2.25
inches	0.19	0.020	0.16	0.067 0.045	0.021 0.015	0.014 0.009	2.067 2.028	0.56 0.54	0.10	0.60	0.14 0.12	0.62 0.60	0.69 0.63	0.01	0.089

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

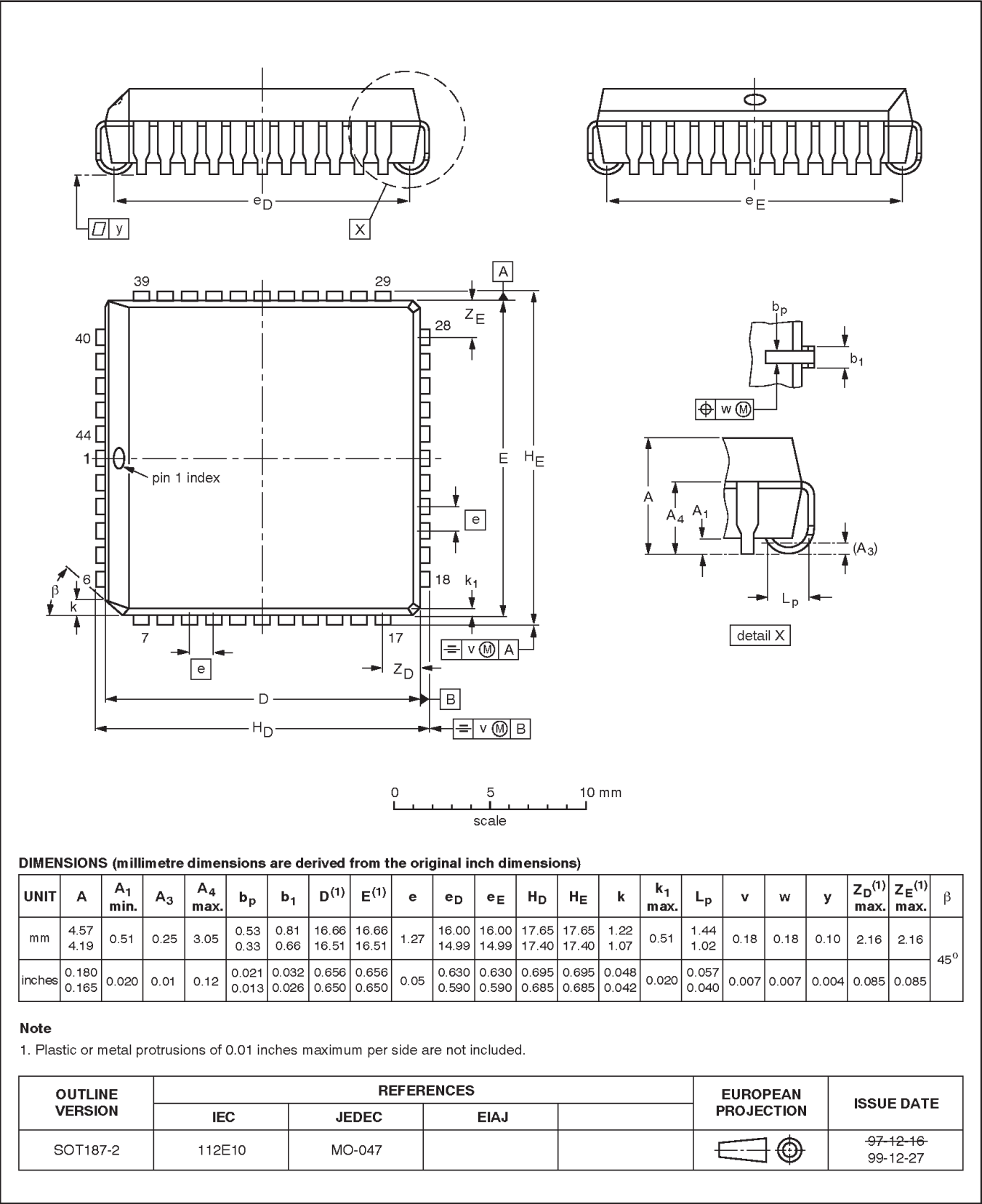
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT129-1	051G08	MO-015	SC-511-40			95-01-14 99-12-27

80C51 8-bit microcontroller family
128/256 byte RAM ROMless low voltage (2.7V–5.5V),
low power, high speed (33 MHz)

80C31/80C32

PLCC44: plastic leaded chip carrier; 44 leads

SOT187-2

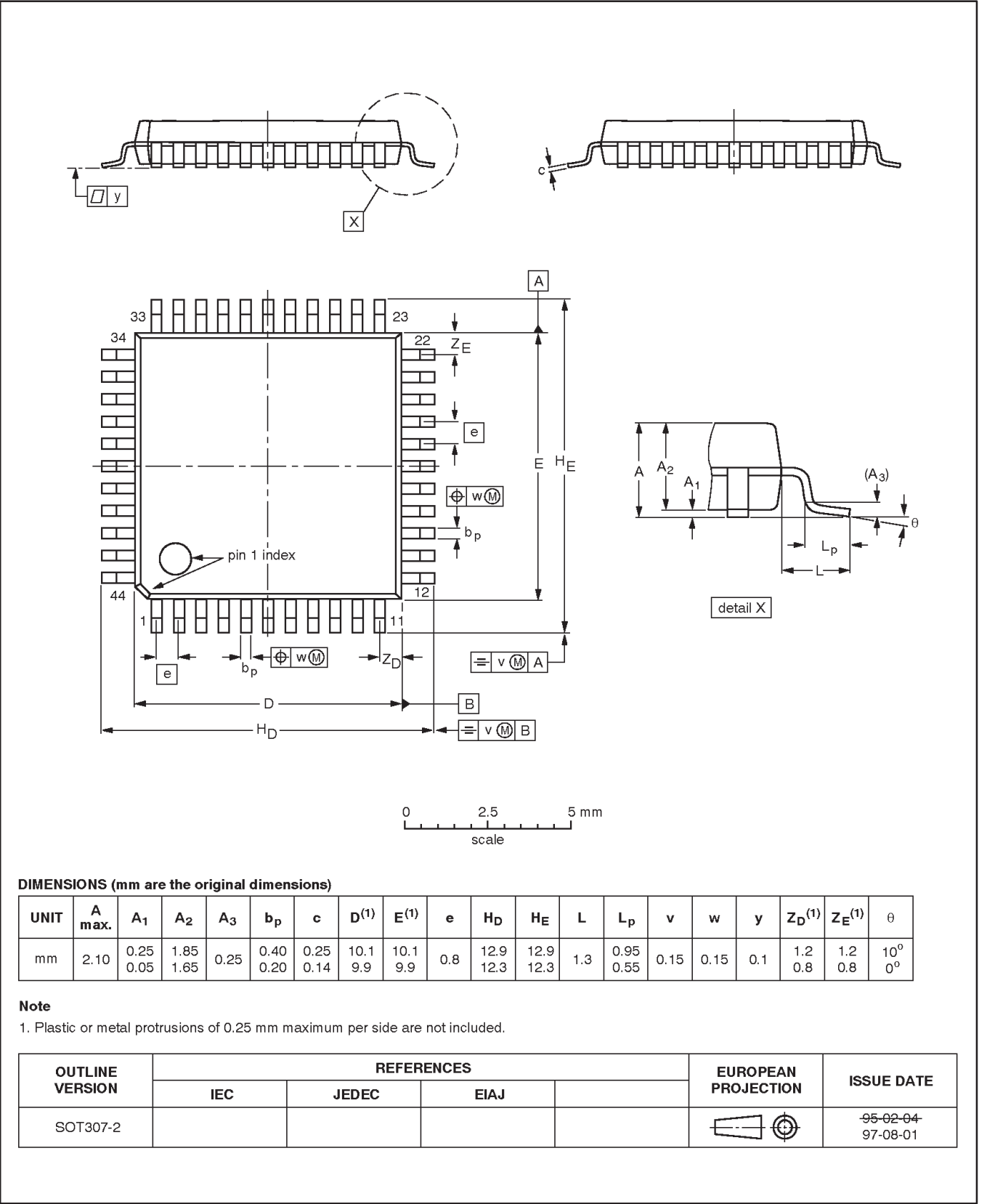


80C51 8-bit microcontroller family
128/256 byte RAM ROMless low voltage (2.7V–5.5V),
low power, high speed (33 MHz)

80C31/80C32

QFP44: plastic quad flat package; 44 leads (lead length 1.3 mm); body 10 x 10 x 1.75 mm

SOT307-2



80C51 8-bit microcontroller family
 128/256 byte RAM ROMless low voltage (2.7V–5.5V),
 low power, high speed (33 MHz)

80C31/80C32

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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